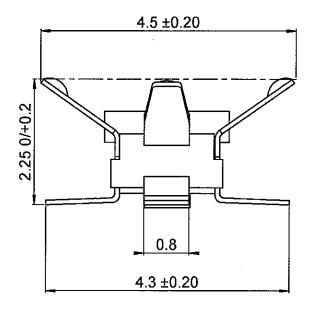
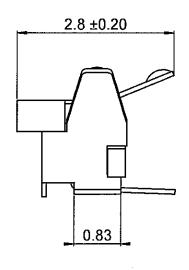
**REEL OF 3500** 

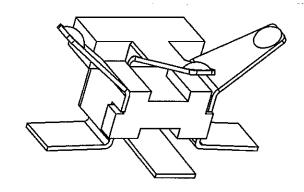
R107.064.080

Series: IMP





**∞** Scale : 1/1



All dimensions are in mm.



		· - T
COMPONENTS	MATERIALS	PLATINGS (μm)
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS	BERYLLIUM COPPER , BERYLLIUM COPPER BERYLLIUM COPPER POLYETHER ETHERCETONE 30% GF	GOLD 0.5 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2
		-
		i e

Issue: 0444 B



**REEL OF 3500** 

R107.064.080

Series: IMP

#### **PACKAGING**

Standard	Unit	Other
3500	•	Contact us

#### **SPECIFICATION**

## **ELECTRICAL CHARACTERISTICS**

Impedance

50 Ω

Frequency **VSWR** 

0-6 GHz

1.5 +0.000 x F(GHz) Maxi

Insertion loss RF leakage

**0.3**  $\sqrt{F(GHz)}$  dB Maxi NA - F(GHz)) dB Maxi

Voltage rating Dielectric withstanding voltage

Insulation resistance

100 Veff Maxi 350 Veff mini

- (

3000  $M\Omega$  mini

#### **ENVIRONMENTAL**

Operating temperature

-40/+90 °C

Hermetic seal Panel leakage

NA Atm.cm3/s

NA

# **OTHERS CHARACTERISTICS**

Assembly instruction

Others:

### MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end Axial force – Opposite end NA N mini NA N mini

Torque

NA N.cm mini

Recommended torque

Mating Panel nut NA N.cm NA N.cm

Mating life

10 Cycles mini

Weight

0.013 g

**Issue:** 0444 B



**REEL OF 3500** 

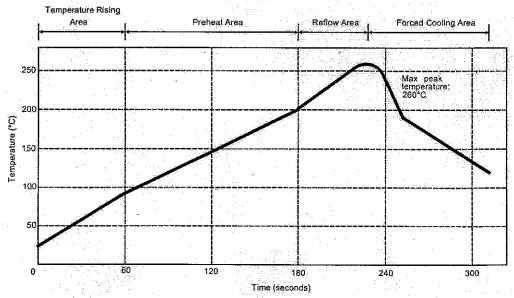
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#### SOLDER PROCEDURE

- 1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
  - We advise a thickness of 150 microns (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven. Below please find, the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

#### TEMPERATURE PROFILE



Parmeter	Value	Unit
	value	
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

Issue: 0444 B



**REEL OF 3500** 

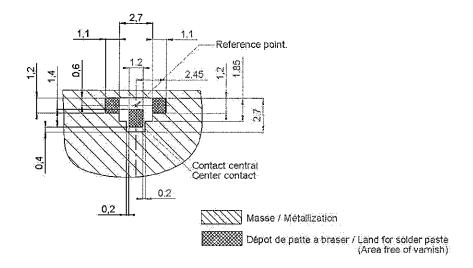
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#### IMP SERIES INFORMATION

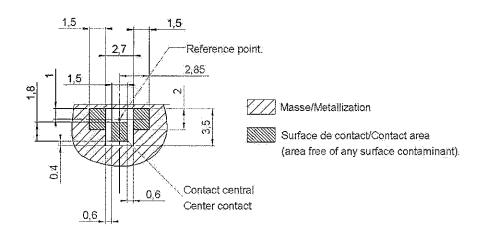
All dimension are in mm

# PCB<sub>1</sub>



Vias and transmission line inside PCB are not represented. The impedance of the transmission line should be 50 ohms

# PCB 2



Vias and transmission line inside PCB are not represented. The impedance of the transmission line should be 50 ohms

Issue: 0444 B

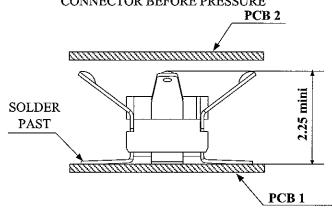


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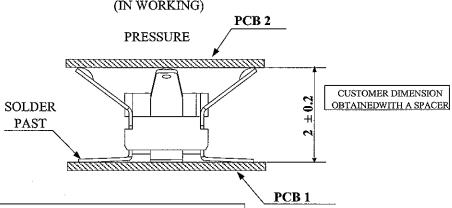
**REEL OF 3500** 

Series: IMP





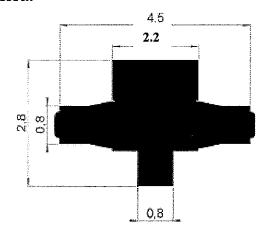
# CONNECTOR IN PRESSURE (IN WORKING)



THE CONNECTOR IS NOT A SPACER, SO THE  $2\pm0.2$  DIMENSION A MUST BE ENSURED WITH AN ADDED PIECE. PART SETTED 10 mm MAX.FAR FROM THE IMP CONNECTOR.

# Shadow of IMP receptacle for video camera.

All dimensions are in mm.



Issue:  $0444 \, \mathrm{B}$  In the effort to improve our products, we reserve the right to make changes judged to be necessary.

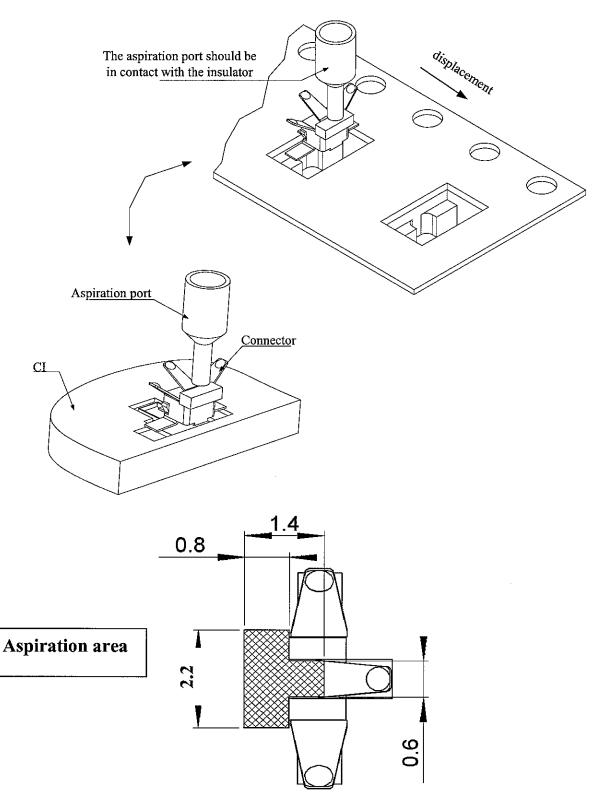


**REEL OF 3500** 

R107.064.080

Series: IMP

# **IMP-SERIES-INFORMATION**



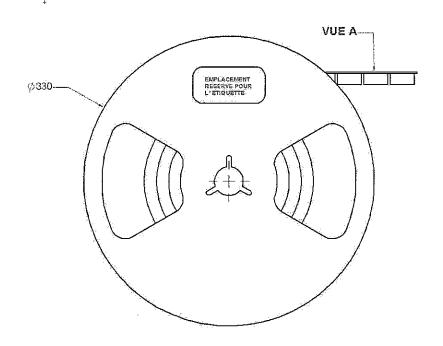
**Issue:** 0444 B

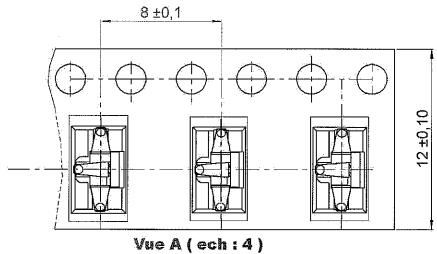


**REEL OF 3500** 

R107.064.080

Series: IMP





**Issue:** 0444 B

